# \$40.00 13125106

## PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Satoshi USUI	04/13/2011
Shingo TAMURA	04/13/2011
Katsumi MIYAZAKI	04/13/2011
Hiroyuki YAMADA	04/13/2011

## **RECEIVING PARTY DATA**

Name:	HITACHI AUTOMOTIVE SYSTEMS, LTD.
Street Address:	2520, Takaba
City:	Hitachinaka-shi, Ibaraki
State/Country:	JAPAN
Postal Code:	312-8503

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	13125106

# **CORRESPONDENCE DATA**

Fax Number: (202)628-8844

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 2026242500

Email: KDombrowski@crowell.com
Correspondent Name: Crowell & Moring LLP
Address Line 1: P.O. Box 14300

Address Line 4: Washington, DISTRICT OF COLUMBIA 20044-4300

ATTORNEY DOCKET NUMBER: 105786.63517US

NAME OF SUBMITTER: Michael H. Jacobs

Total Attachments: 1

source=63517US\_ASSIGN\_1#page1.tif

REEL: 026307 FRAME: 0855

ATENT

# **ASSIGNMENT**

(譲渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI AUTOMOTIVE SYSYTEMS, LTD., a corporation organized under the laws of Japan,

located at 2520, Takaba, Hitachinaka-shi, Ibaraki 312-8503 Japan,

receipt of which is hereby acknowledged I do hereby sell and assign to sa HITACHI AUTOMOTIVE SYSYTEMS, LTD., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

#### HIGH-PRESSURE FUEL PUMP

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters—Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted,

to be held and enjoyed by said HITACHI AUTOMOTIVE SYSYTEMS, LTD.,

its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made:

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference preceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI AUTOMOTIVE SYSYTEMS, LTD.,

Signed on the date(s) indicated aside our signatures:

INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1) Satoshi Voni	4/13/2011
1) Satushi Voui Satushi USUI 2) Lamura Shinga TAMURA	4/13/2011
3) K. Mywzahi	4/13/2011
Katsumi MIYAZAKI 4) Hiroju ki Jana La	4/13 /2011
Hiroyuki YAMADA 5	
6)	
7)	
8)	
9)	
10)	

PATENT REEL: 026307 FRAME: 0856

RECORDED: 05/19/2011